

Understanding the Reference electrode



Measuring Potentials



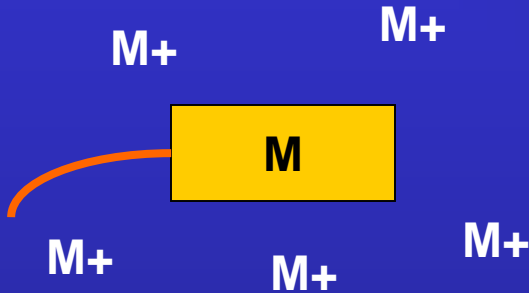
- When measuring potential, you are actually measuring the difference in potential between two electrodes.
- If the measured potential changes, it means that the potential of one of the two electrodes has changed.
- Which one changed?

Simple Electrodes ...

- transfer electricity from a solid conductor to a liquid electrolyte
- make the transfer by means of a chemical reaction at the electrode surface
- establish an electrical potential unique to reaction
- In a reference electrode, the electrolyte, metal and reaction are precisely defined to produce a consistent potential

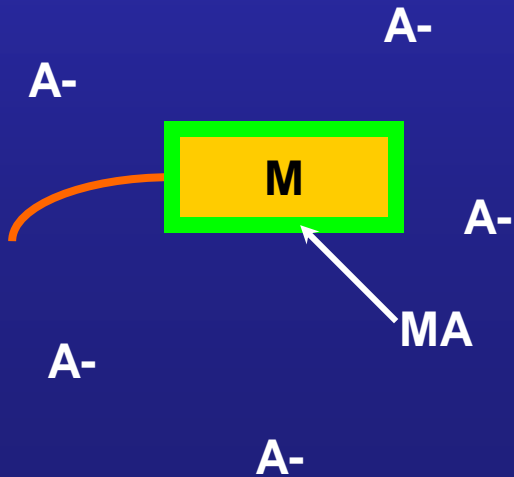
Two Kinds of Electrodes

1st kind



$$E = E_0 + 2.3 \frac{RT}{nF} \log(M^+)$$

2nd kind



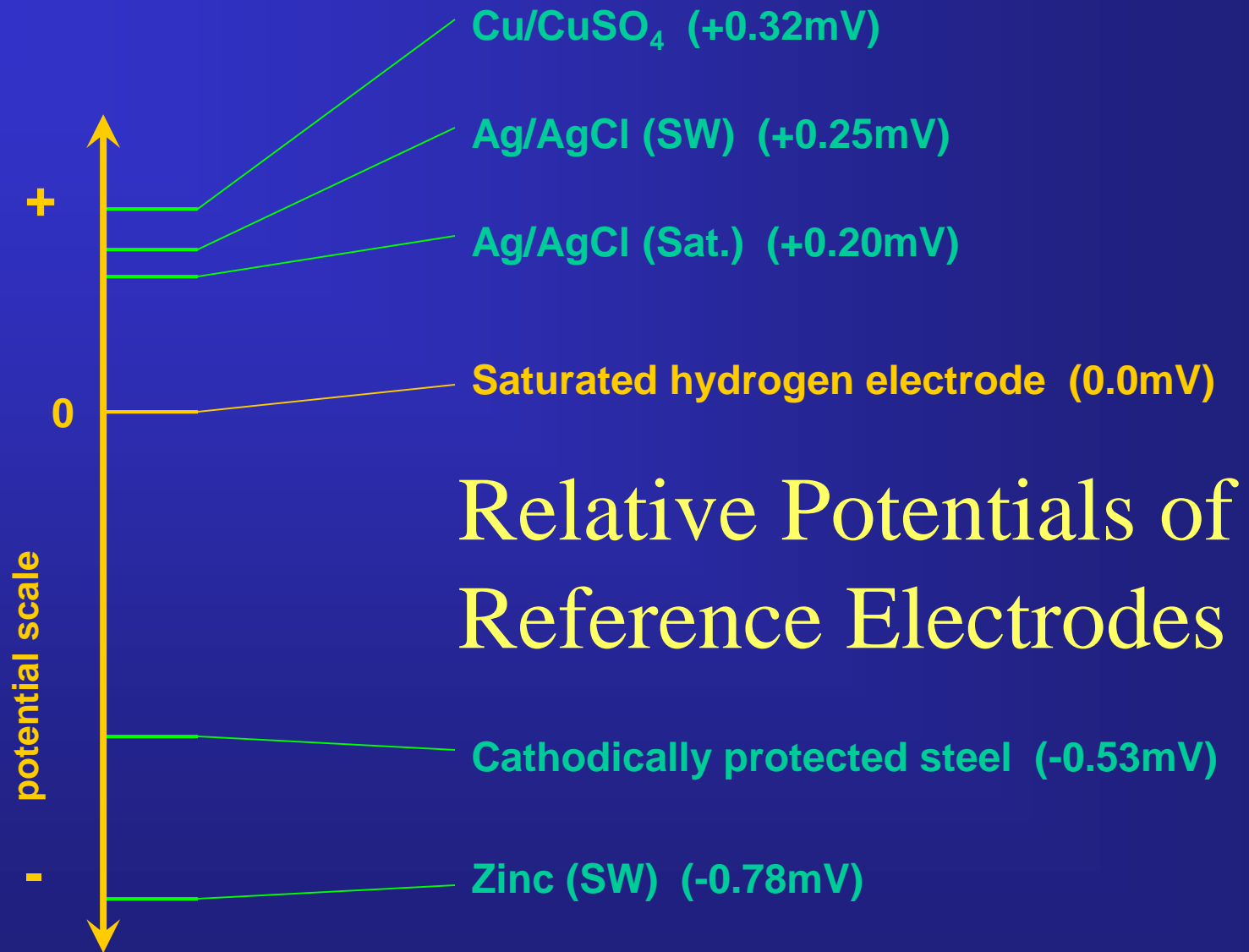
$$E = E_0 + 2.3 \frac{RT}{nF} \log(A^-)$$

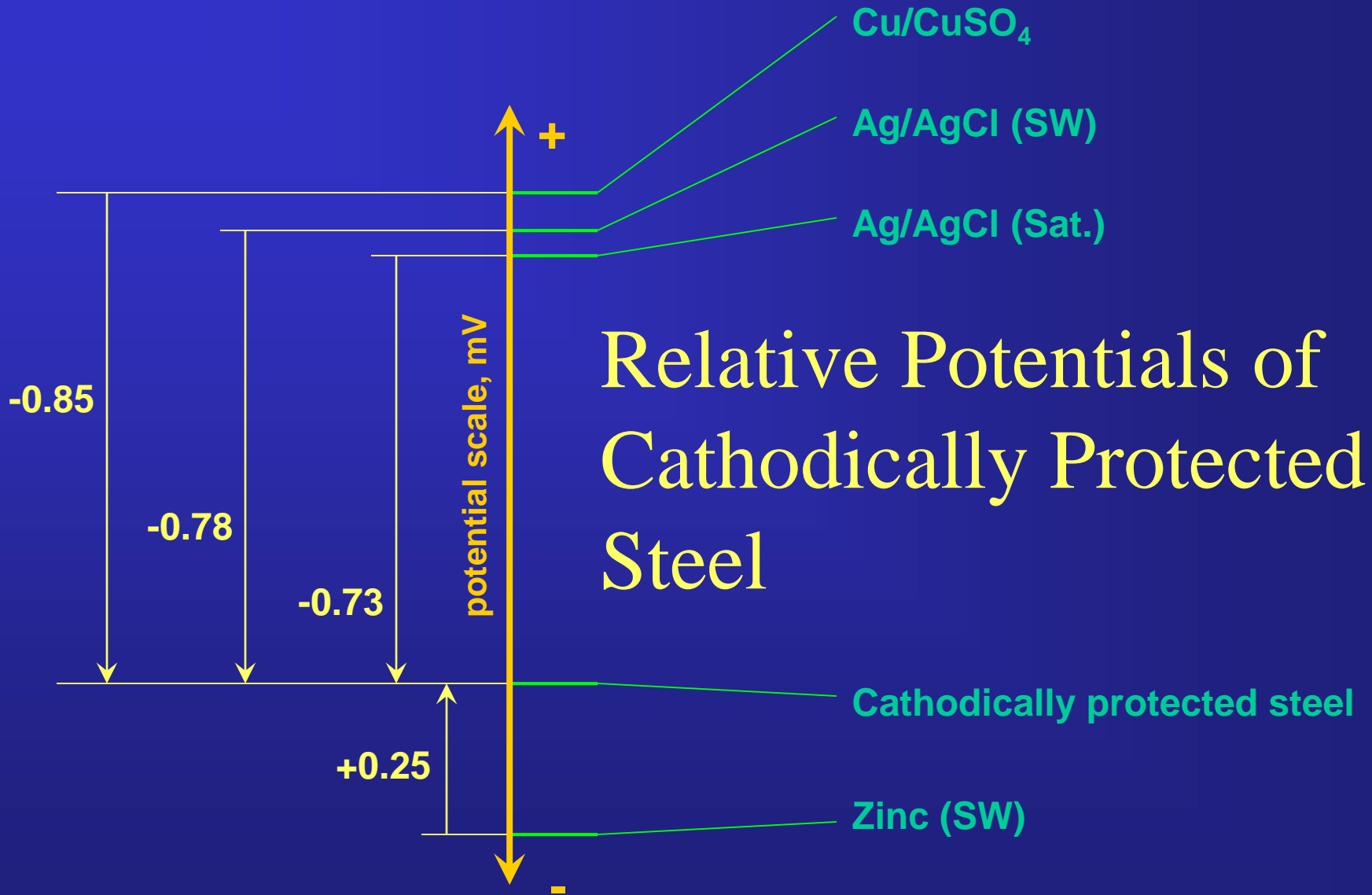
Electrolyte Forms

- Dry electrode – Element in direct contact with the structure electrolyte
- Wet electrode – Element immersed in a salt solution and separated from the environment by a porous plug
- Gelled electrode – Element immersed in a gelled salt solution and separated from the environment by a conducting membrane

Commonly Used Reference Electrodes

- Copper/copper sulfate (Cu/CuSO_4)
 - Underground
 - Fresh water
- Silver/silver chloride (Ag/AgCl)
 - Seawater
 - Saline mud
 - Concrete



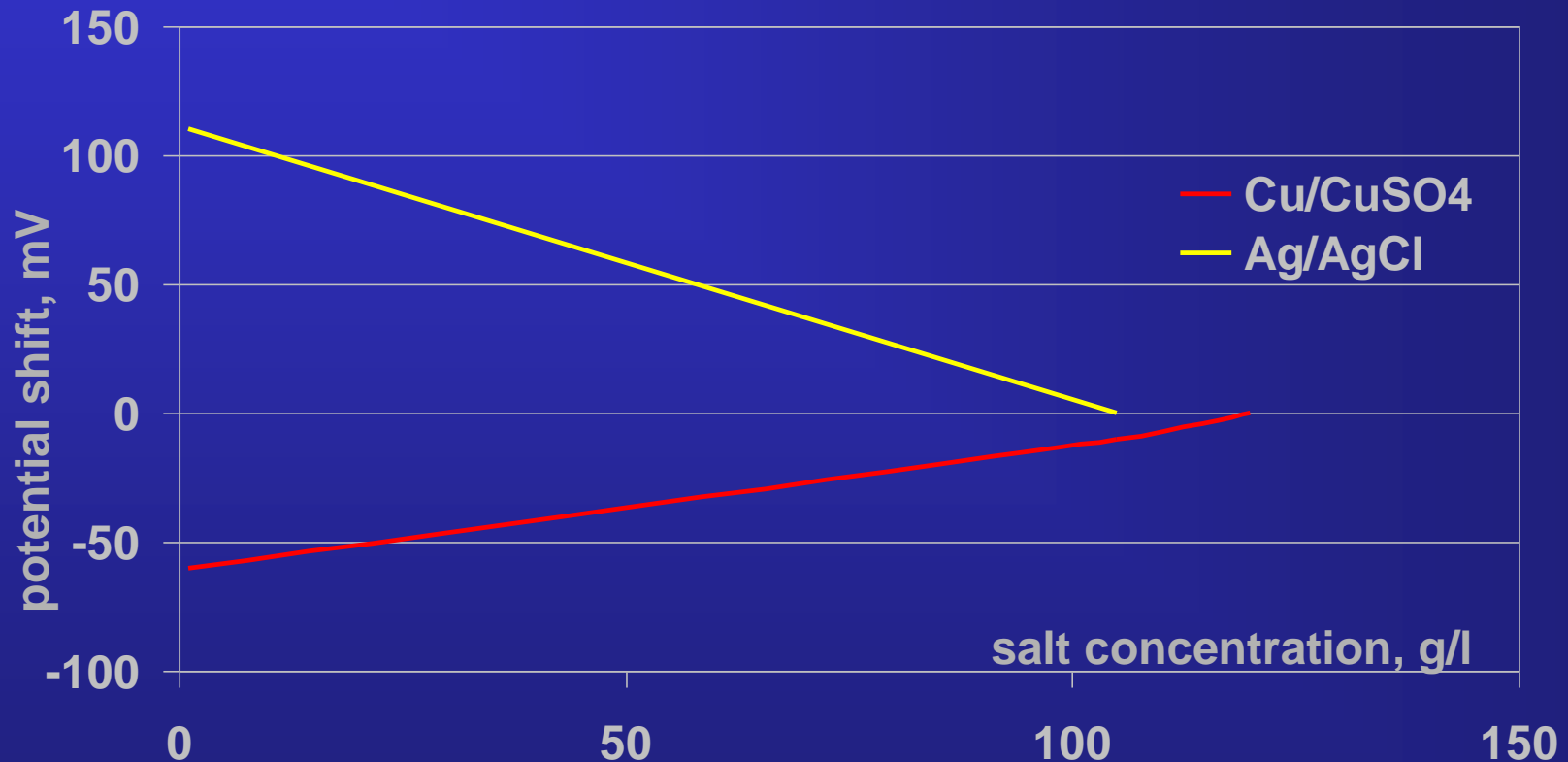


External Influences

Reference potential is influenced by

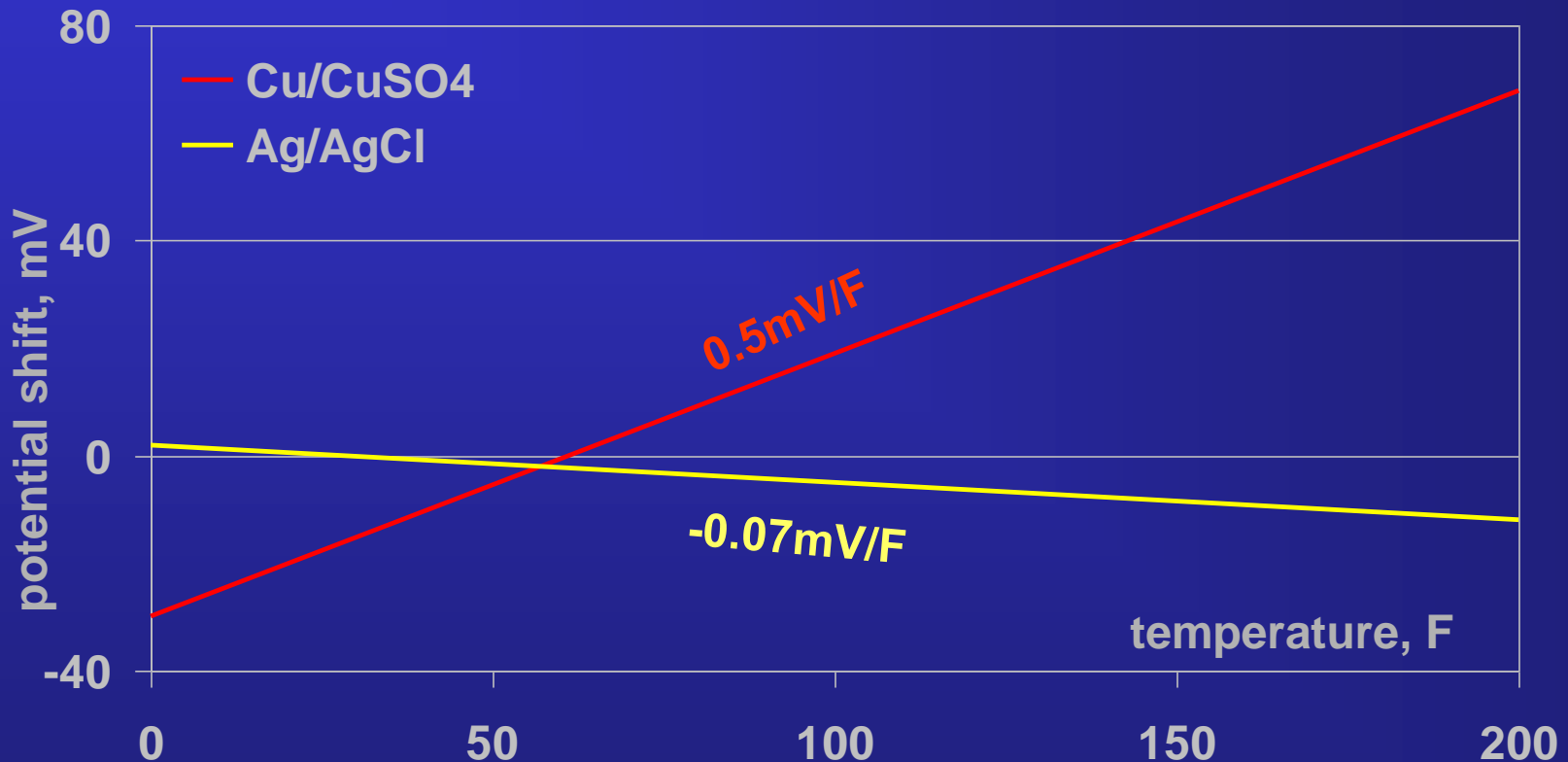
- Electrolyte Concentration
- Temperature
- Electrolyte Contamination
- Light

Electrolyte Concentration Affects Potential



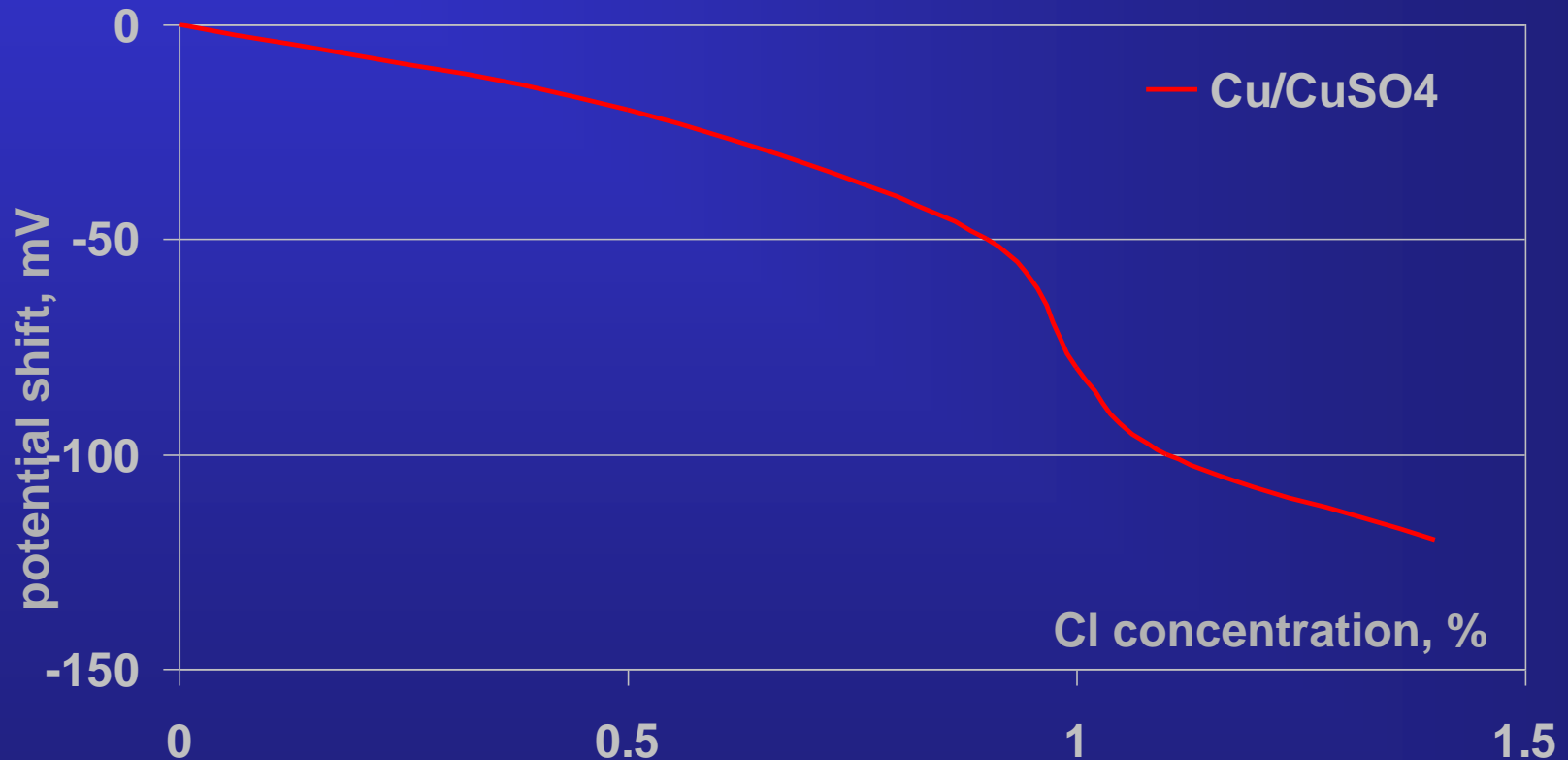
As the electrolyte salt concentration drops:
Cu/CuSO₄ references drift in the negative direction,
Ag/AgCl references drift in the positive direction.

Reference Electrodes are Temperature Sensitive



As the temperature increases: Cu/CuSO₄ references drift in the positive direction, Ag/AgCl references drift in the negative direction.

Contamination Affects Reference Potential



Cu/CuSO₄ references should not be used in chloride contaminated environments.



Cu/CuSO₄ Reference Electrodes are Light Sensitive

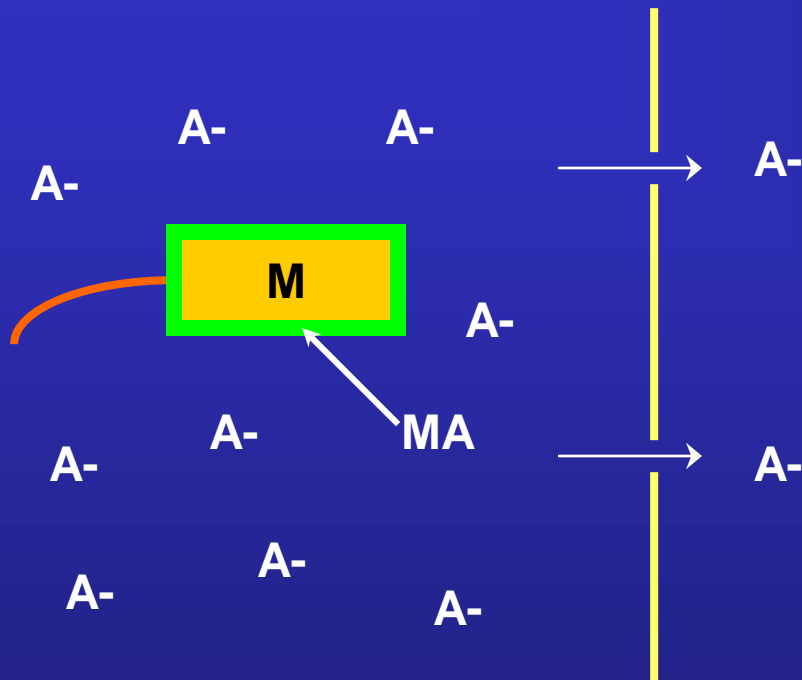
High Noon	-52mV
Open Shade	-10mV
Interior Fluorescent	-2mV

TEST METHOD

- NACE TM0113-2013
- Evaluating the Accuracy of Field-Grade Reference Electrodes

PERMANENTLY INSTALLED
REFERENCE ELECTRODES

Service Life – Effect of Diffusion



- Diffusion rate increases with
 - Temperature
 - Membrane area
 - Concentration difference

When the salt concentration or composition at the element changes, the reference potential will shift.

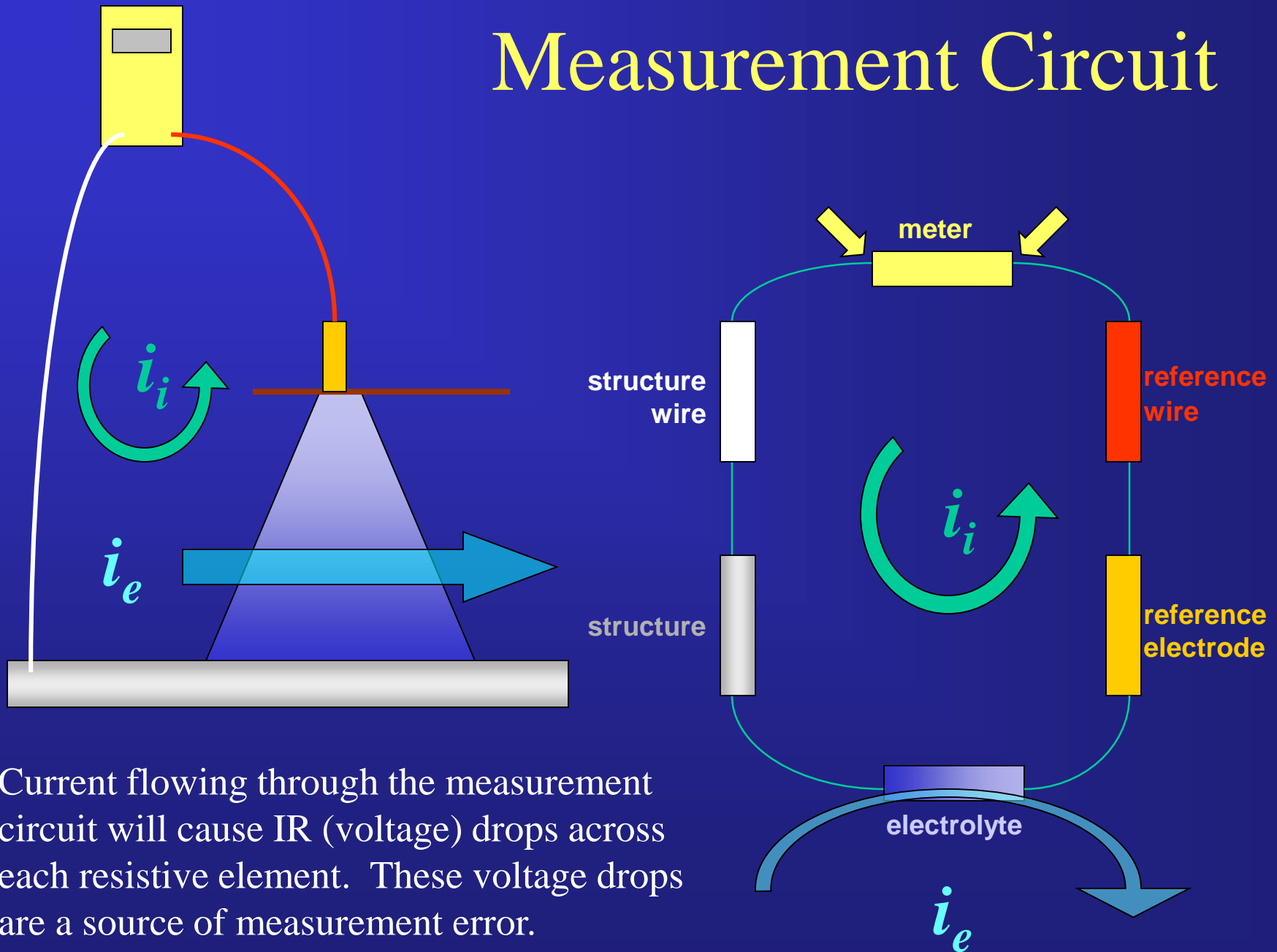
Service Life Factors

- Design
 - Electrolyte path length
 - Ion flow control
- Chemical
 - Gel binder composition
 - Salt loading
- Environmental
 - Electrolyte flow rate
 - Electrolyte contamination

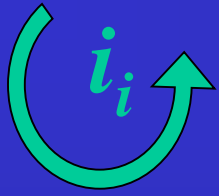
Failure Mechanisms

- Change of electrolyte ion concentration
- Electrolyte contamination
 - Cu/CuSO₄: chlorides & sulfides
 - Ag/AgCl: sulfides & other halides
- Loss of electrical circuit continuity
 - Wire failure
 - Electrolyte dry-out

Measurement Circuit



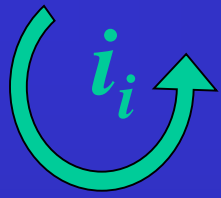
Current flowing through the measurement circuit will cause IR (voltage) drops across each resistive element. These voltage drops are a source of measurement error.



Measurement Errors

Internal IR Drop

- Internal IR drop results from current flowing through the measurement circuit
- Reduce by using a higher input impedance meter or potentiometric voltmeter
 - 10 megohm (min.) for water and damp soil
 - 100 megohm (min) for semi-dry soil and concrete
- Measurements through asphalt should be avoided because asphalt is an insulator



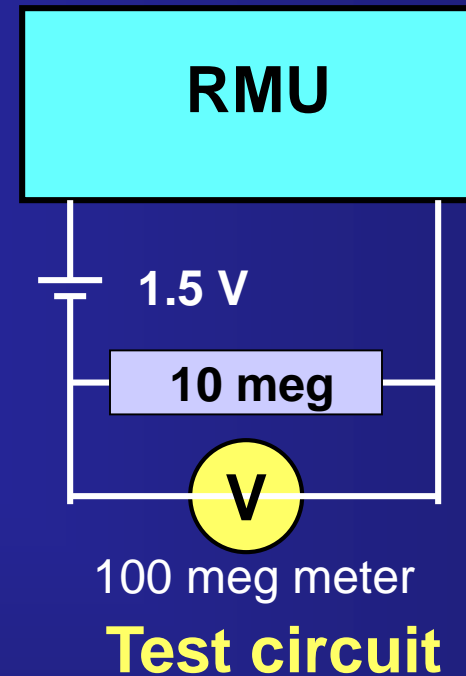
Measurement Errors

Remote Monitoring Units

Input impedance on some RMUs drop when they are in stand-by or turned off.

Excessive current flowing through a reference electrode will shift the potential or destroy the cell.

Input impedance must not drop below 10 megohms as unit is cycled through off, on-standby and on-measuring.





- External IR drop results from current flowing through electrolyte, either from the CP system or stray currents from other sources
- Small reductions obtained by placing the reference close to the structure
- Larger reductions obtained by interrupting CP current or using CP coupons

